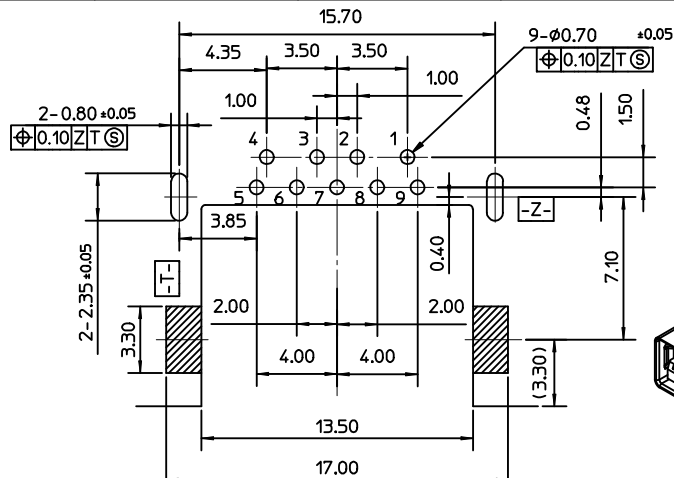
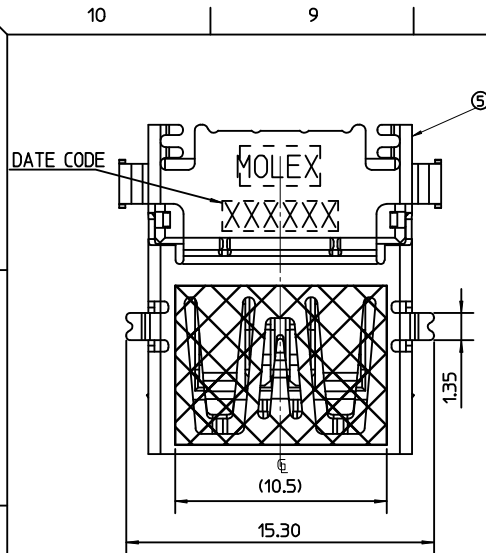
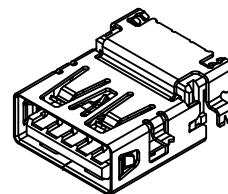




RECOMMENDED PCB LAYOUT (T=1.20mm)
GENERAL TOLERANCE ± 0.05



NOTES:

1. MATERIAL:

1.1 HOUSING: THERMOPLASTIC, HIGH TEMP., UL94V-0,
COLOR: BLUE

1.2 CONTACT: COPPER ALLOY

1.3 SHELL: STAINLESS STEEL

2. FINISH:

2.1 CONTACT: PLS. SEE TABLE INFORMATION

SOLDER TAIL PLATING: MATT TIN OVER NICKEL

UNDERPLATING: NICKEL OVER ALL

2.2 SHELL: NICKEL PLATING OVER ALL

3. SPEC. PLS. REFER TO PS- 48397-001

4. PACKAGE PLS. REFER TO PK- 48397-001

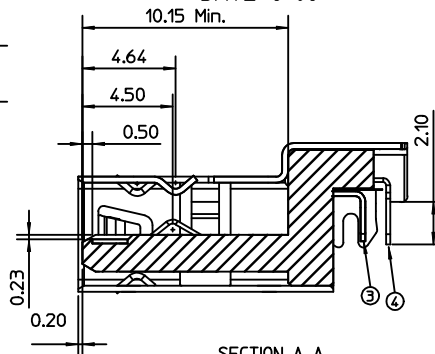
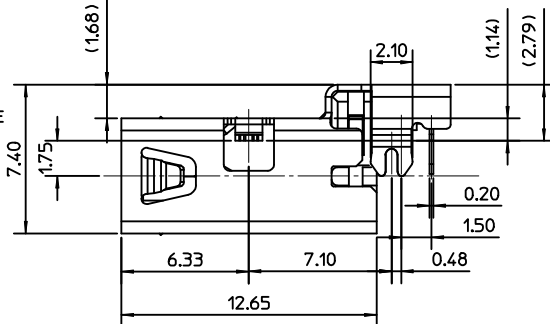
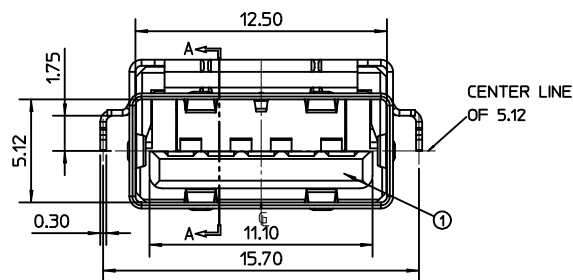
5. LEAD FREE AND ROHS COMPLIANT PRODUCT

6. DATE CODE

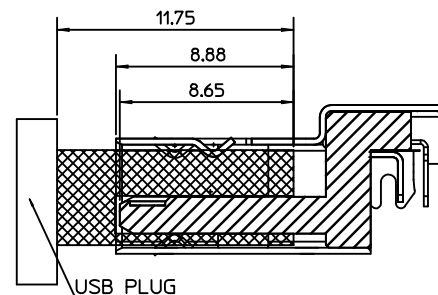
YEAR: 1=2011
MONTH: A(JAN). B(FEB)
DATE: 8=08

1 A 08 X X

REMARK
PRODUCE PLACE



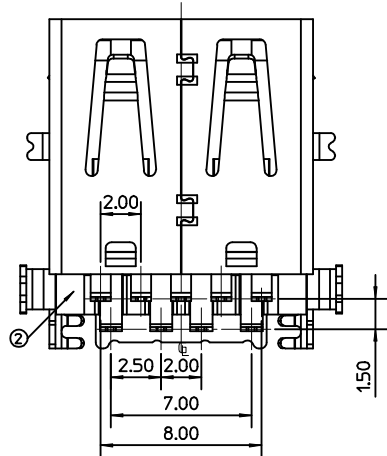
SECTION A-A



TABLE

PLATING	MOLEX P/N
30u GOLD	48397-0001
2u GOLD & 30u Pd-Ni	48397-0002
15u GOLD	48397-0003
GOLD FLASH(3u MIN)	48397-0004

5	METAL SHELL	STAINLESS STEEL
4	TERMINAL A	COPPER ALLOY
3	TERMINAL B	COPPER ALLOY
2	SPACER	THERMOPLASTIC
1	HOUSING	THERMOPLASTIC
No.	DESCRIPTION	MATERIAL



SHELL	SHIELD
9	STDA_SSTX+
8	STDA_SSTX-
7	GND_DRAIN
6	STDA_SSRX+
5	STDA_SSRX-
4	GND
3	D+
2	D-
1	VBUS
PIN NO.	SIGNAL NAME

RELEASE
EC NO: DRWNYANG05 2013/10/20
CHKD: APPR:

QUALITY
SYMBOLS
F_A=0
F_{RT}=0
F_P=0

GENERAL TOLERANCES
(UNLESS SPECIFIED)

	mm	INCH
4 PLACES		
3 PLACES		
2 PLACES	± 0.25	
1 PLACE	± 0.25	

ANGULAR $\pm 3^\circ$

DRAFT WHERE APPLICABLE
MUST REMAIN
WITHIN DIMENSIONS

DIMENSION STYLE
MM ONLY

DRAWN BY DATE
WanBo 2013/04/05

CHECKED BY DATE
SAM 2013/04/05

APPROVED BY DATE
JASON 2013/04/05

MATERIAL NO.

SIZE
A4

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX
INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

SCALE
1:1

DESIGN UNITS
METRIC

THIRD ANGLE
PROJECTION

TITLE
USB3.0 REVERSE SINK A
TYPE CH=1.75mm T/H R/A

MOLEX MOLEX INCORPORATED

DOCUMENT NO.
SD-48397-001

SHEET NO.
1 OF 1